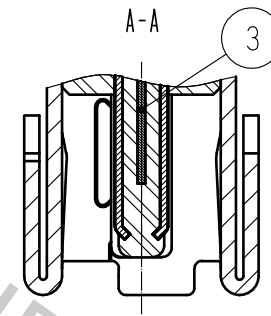
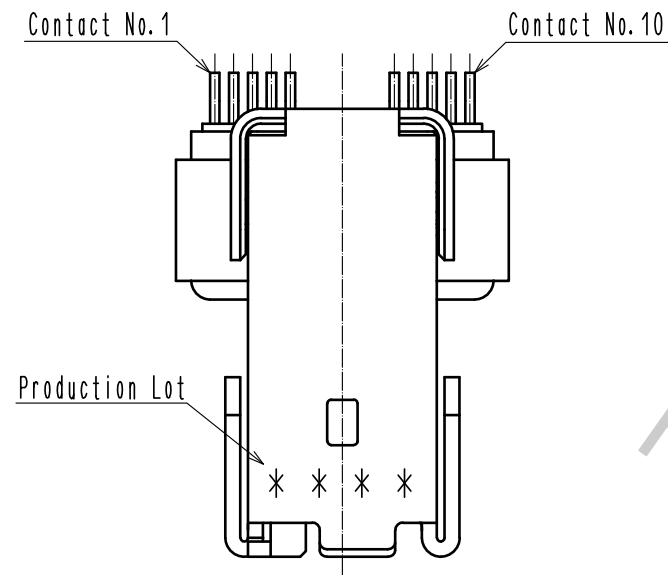
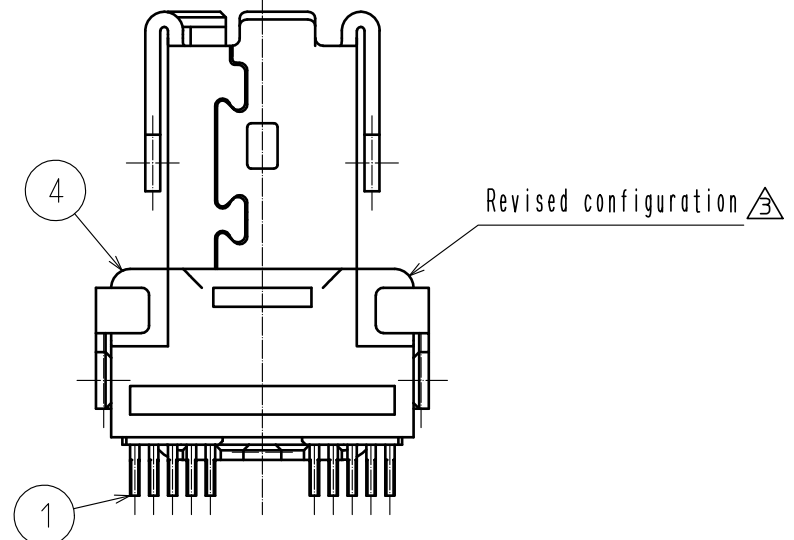
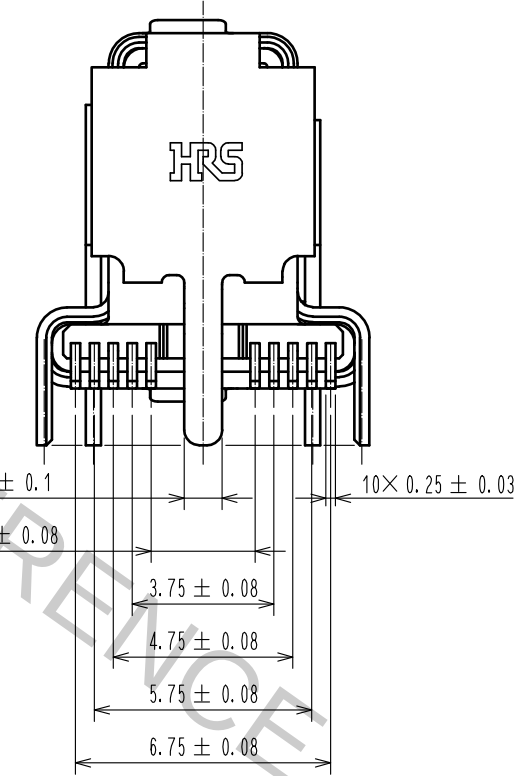
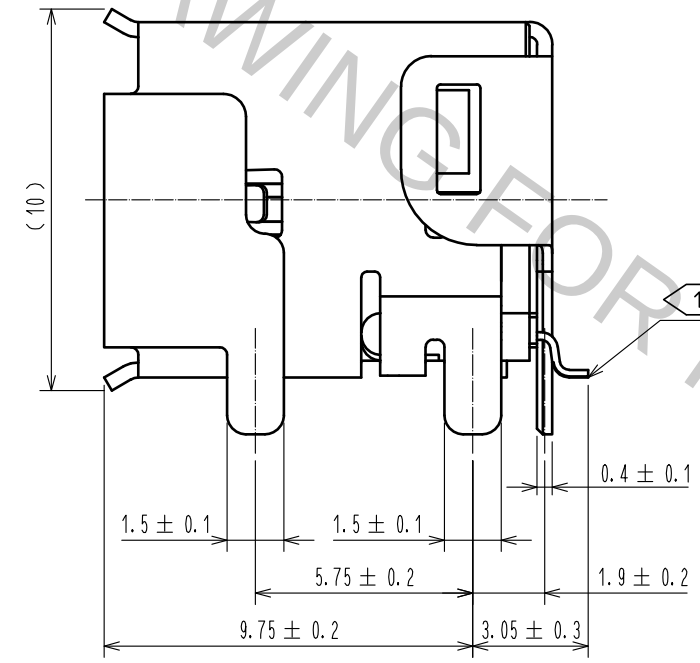
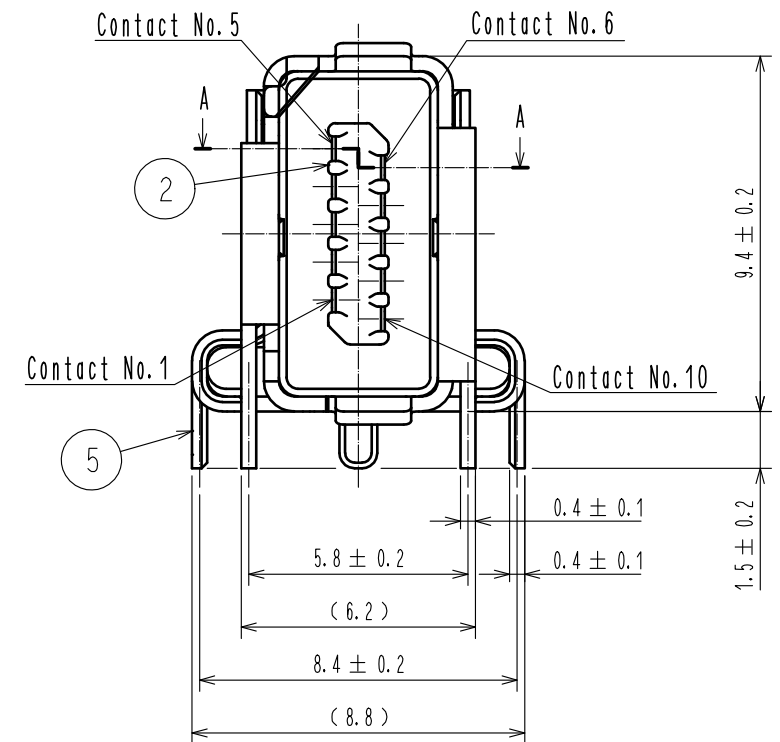


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In case that the application demands a high level of reliability, such as automotive,
please contact a company representative for further information.

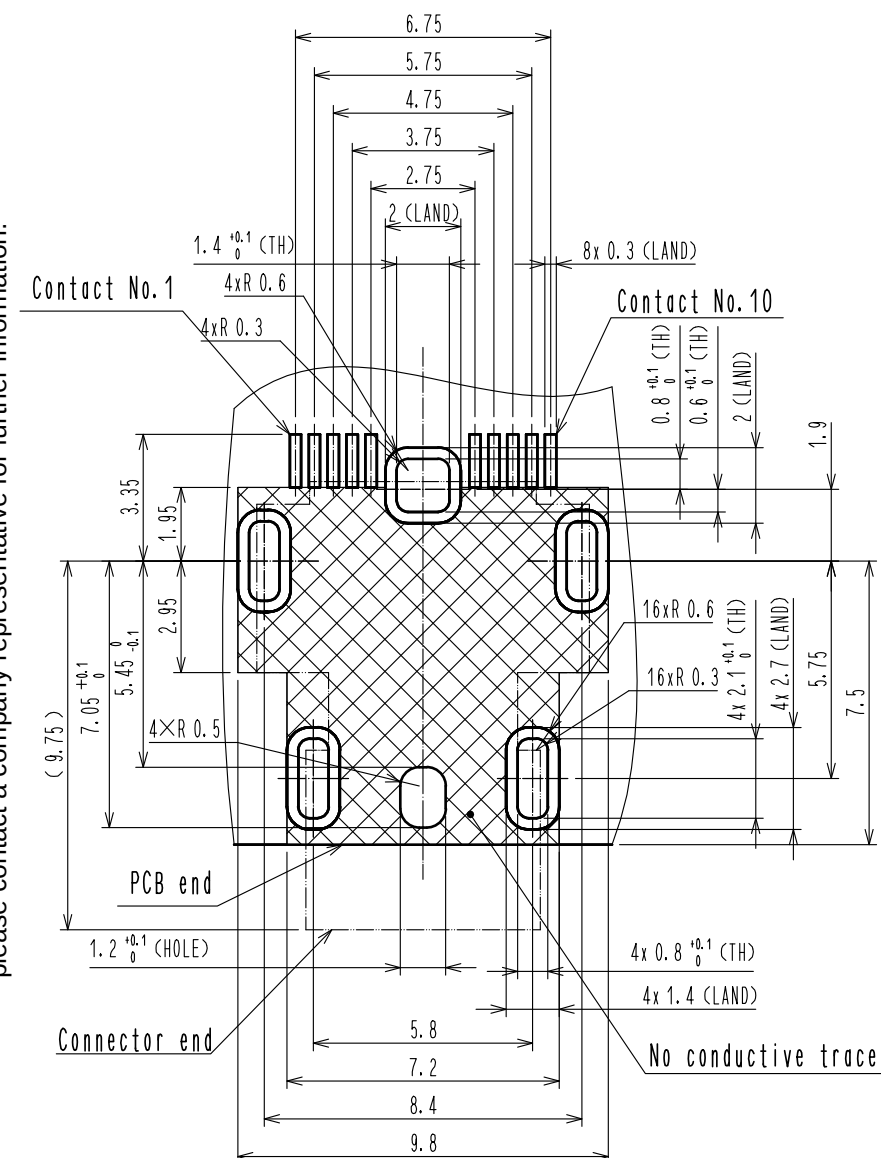


- Notes. 1 Co-planarity is within 0.1 mm.
- 2 As for part No.5 the performance remains good even if there are rubbing wounds by the assembly process.
And the performance remains good though there might be a difference in the plating luster between each plating lots.
- 3 Per reel : 400 pcs.
- 4 Refer to the mated condition diagram for the panel thickness and layout.
- 5 This product is mounted by reflow soldering.
Refer to specification sheet ELC-129488-01-00 for reflow soldering.



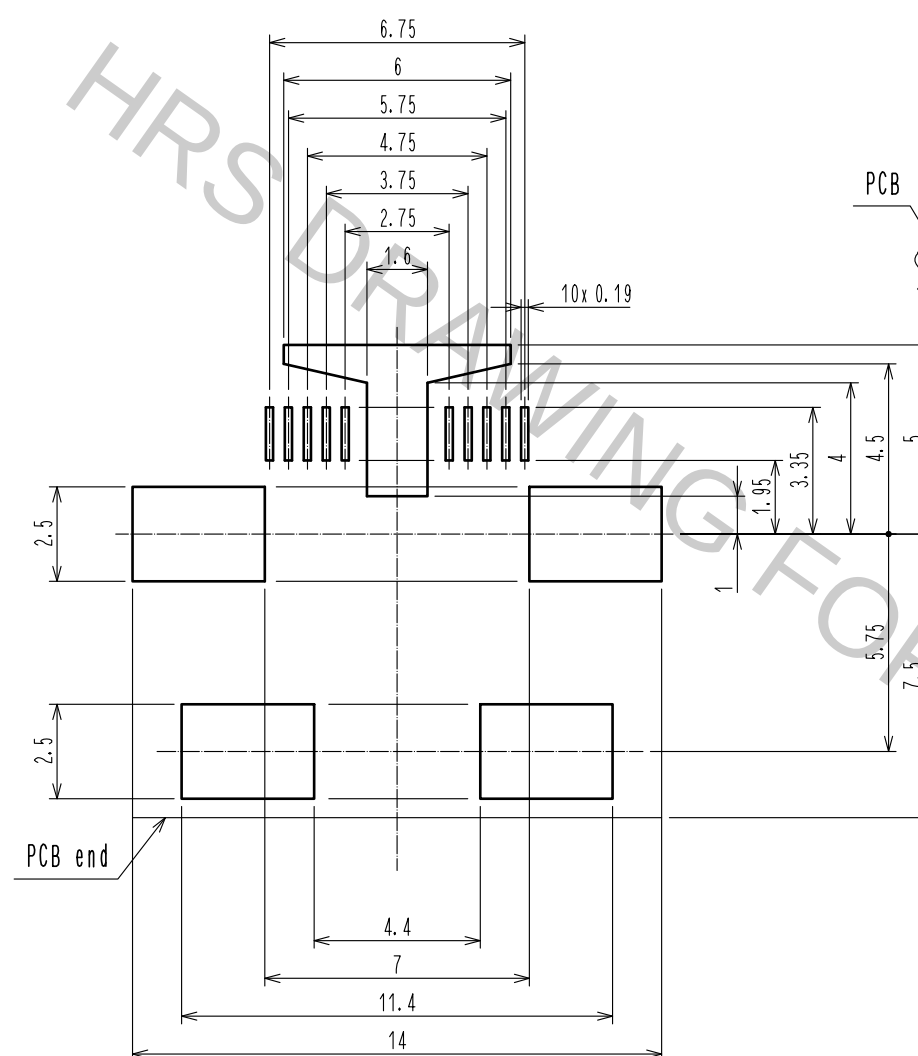
3	Stainless Steel		7	PE	
2	LCP	Gray, UL94V-0	6	PS	
1	Copper Alloy	Contact area : Palladium-Nickel 0.75 μm min. + Gold 0.05 μm min. Wiring area : Gold 0.03 μm min. Under plating : Nickel 2 μm min.	5	Stainless Steel	Surface : Tin 1 μm min. Under plating : Nickel 0.2 μm min.
	MATERIAL	FINISH, REMARKS	NO.	MATERIAL	FINISH, REMARKS
UNITS mm		SCALE 5 : 1	COUNT 2	DESCRIPTION OF REVISIONS DIS-E-00001445	DESIGNED JY. IGA
HIROSE ELECTRIC CO., LTD.		APPROVED : RI. TAKAYASU	17.03.31	DRAWING NO.	EDC-129488-01-00
		CHECKED : KI. NAGANUMA	17.03.31	PART NO.	IX61G-B-10P(C01)
		DESIGNED : SG. CHAMURA	17.03.31	CODE NO.	CL251-0026-0-01
		DRAWN : SG. CHAMURA	17.03.31		
					DATE 18.04.05

Reference PCB Layout (Connector Mounting Side) (t = 1.6)



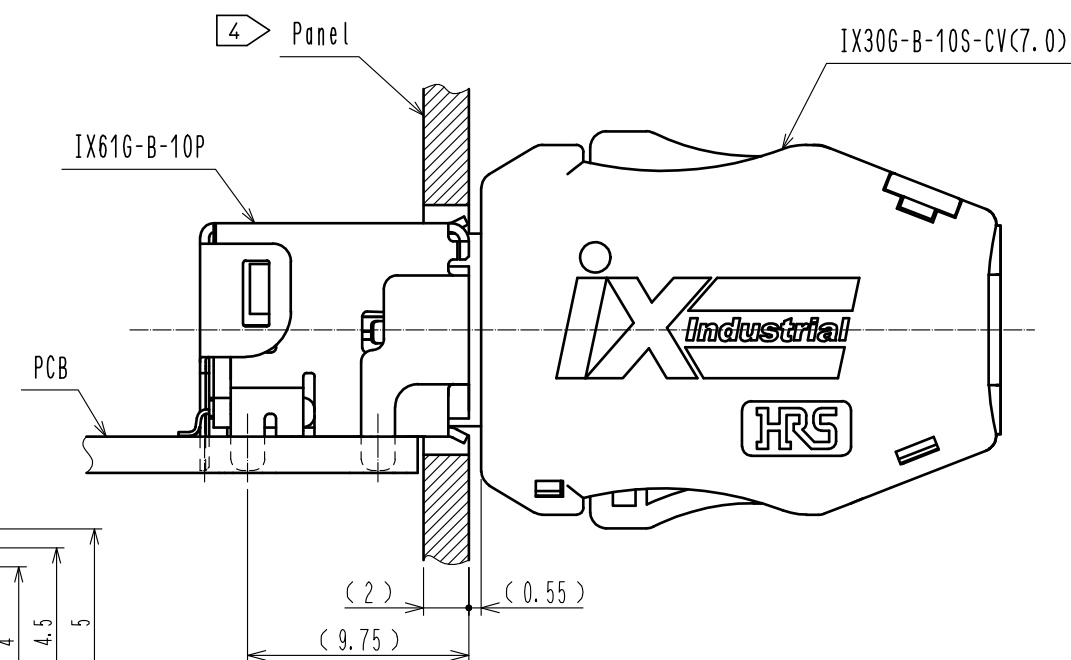
General tolerance is +/- 0.05

Reference Metal Mask Layout (t = 0.15)

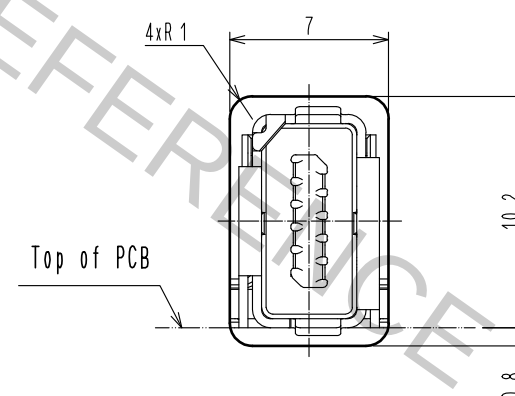


General tolerance is +/- 0.02

Mated Condition (Free)



Reference Dimensions of Panel Cutout (FREE)



Dimension is reference.

Thickness of metal mask is 0.1 mm min.

Metal mask dimensions of the drawings described, are reference dimensions for 0.15 mm thickness metal mask.

Change the metal mask dimensions by thickness of the metal mask, thickness of PCB, component of solder paste and mounting conditions.

Change the metal mask dimensions in case of mounting IX61G-10P in parallel.

Change the metal mask dimensions, if there are other mounting parts or implementation pattern around the portion of mounting position of IX61G-10P.

Refer to the technical specification (ETAD-E3170-00) for different variations of the metal mask pattern width.

HRS

DRAWING NO.	EDC-129488-01-00
PART NO.	IX61G-B-10P(01)
CODE NO.	CL251-0026-0-01

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